Vishay Siliconix

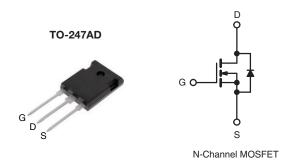
COMPLIANT

HALOGEN

FREE

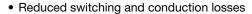
E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	700			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 \text{ V}$	0.072		
Q _g max. (nC)	273			
Q _{gs} (nC)	46			
Q _{gd} (nC)	79			
Configuration	Sing	le		



FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)



- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-free and Halogen-free	SiHW47N65E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	650		
Gate-Source Voltage			.,	± 20	V	
Gate-Source Voltage AC (f > 1 Hz)			V _{GS}	30		
Continuous Drain Current (T _J = 150 °C)		V _{GS} at 10 V	T _C = 25 °C		47	
			T _C = 100 °C	I _D	30	А
Pulsed Drain Current ^a			I _{DM}	139		
Linear Derating Factor				3.3	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	1410	mJ	
Maximum Power Dissipation			P _D	417	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope		T _J = 125 °C		4).//d+	37	1//20
Reverse Diode dV/dt ^d			dV/dt	9	V/ns	
Soldering Recommendations (Peak Temperatu	ure) ^c	for 10 s			300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 10 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$.



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	40	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.3	C/ VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.70	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2	-	4	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		= 650 V, V _{GS} = 0 V /, V _{GS} = 0 V, T _J = 125 °C	-	-	1 25	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	$V_{DS} = 320 \text{ V}$ $V_{GS} = 10 \text{ V}$		_	0.060	0.072	Ω
Forward Transconductance	9fs		= 30 V, I _D = 24 A	_	16.7	-	S
Dynamic	918	* DS	- 30 V, I _D - 2 1 7 V		10.7		
Input Capacitance	C _{iss}		V 0.V	_	5682	-	
Output Capacitance	Coss	1	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		251	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	1	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 520 V, V _{GS} = 0 V		-	192	-	
Effective Output Capacitance, Time Related ^b	$C_{o(tr)}$			-	665	-	
Total Gate Charge	Qq			-	182	273	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 24 \text{ A}, V_{DS} = 520 \text{ V}$		-	46	-	nC
Gate-Drain Charge	Q _{gd}	1			79	-	
Turn-On Delay Time	t _{d(on)}			-	47	94	
Rise Time	t _r	V_{DD} = 520 V, I_{D} = 6 A, V_{GS} = 10 V, R_{g} = 9.1 Ω		-	87	131	- ns
Turn-Off Delay Time	t _{d(off)}			-	156	234	
Fall Time	t _f			-	103	206	
Gate Input Resistance	R_g	f = 1 MHz, open drain		-	0.64	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	47	
Pulsed Diode Forward Current	I _{SM}			-	-	139	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 24 A, V _{GS} = 0 V		-	0.9	1.2	V
Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _S = 24 A, dl/dt = 100 A/μs, V _R = 25 V		-	753	1506	ns
Reverse Recovery Charge	Q _{rr}			-	14	28	μC
Reverse Recovery Current	I _{RRM}			_	28	-	Α

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

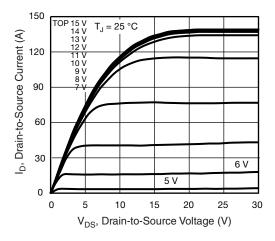


Fig. 1 - Typical Output Characteristics

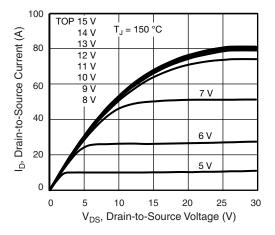


Fig. 2 - Typical Output Characteristics

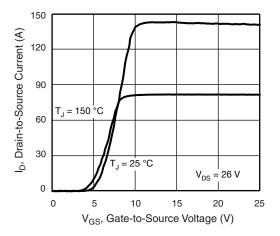


Fig. 3 - Typical Transfer Characteristics

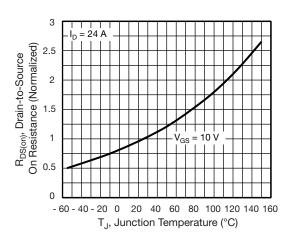


Fig. 4 - Normalized On-Resistance vs. Temperature

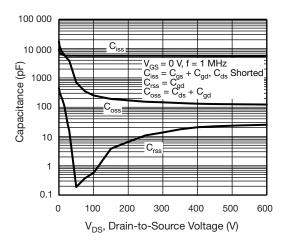


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

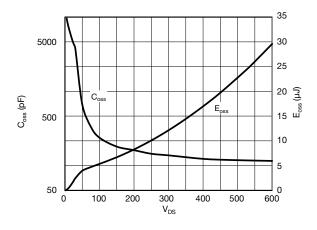


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



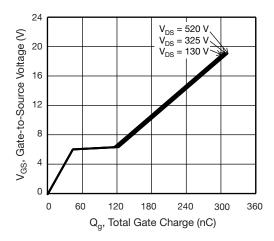


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

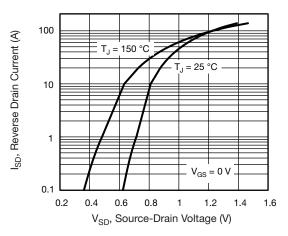


Fig. 8 - Typical Source-Drain Diode Forward Voltage

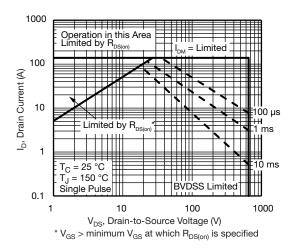


Fig. 9 - Maximum Safe Operating Area

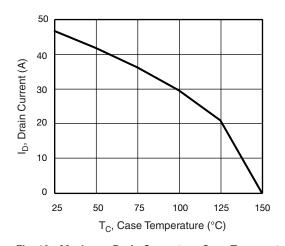


Fig. 10 - Maximum Drain Current vs. Case Temperature

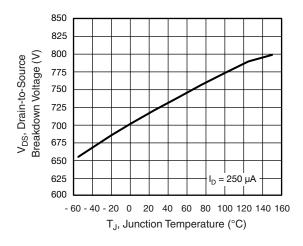


Fig. 11 - Temperature vs. Drain-to-Source Voltage



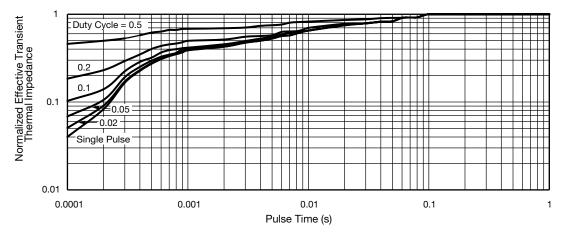


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

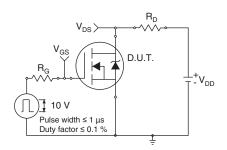


Fig. 13 - Switching Time Test Circuit

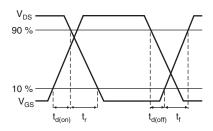


Fig. 14 - Switching Time Waveforms

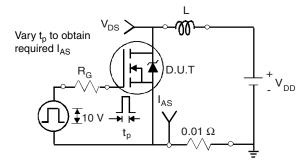


Fig. 15 - Unclamped Inductive Test Circuit

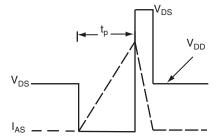


Fig. 16 - Unclamped Inductive Waveforms

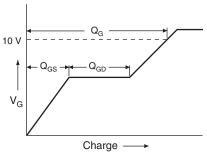


Fig. 17 - Basic Gate Charge Waveform

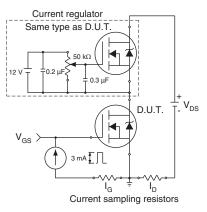
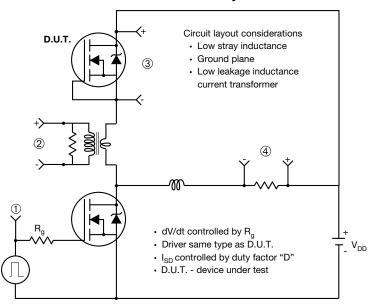


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



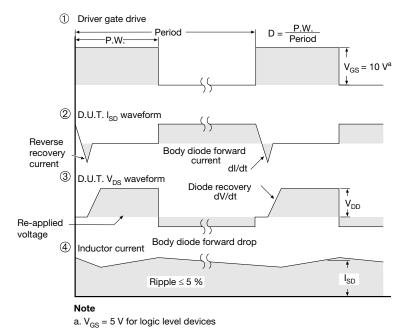


Fig. 19 - For N-Channel

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